



Part Number : 2048430001

Product Description : Mirror Mezz  
Hermaphroditic Connector, 2.50mm  
Connector Height, BGA-Attach Mounting, 7  
Pair, 11 Row, 699 Circuits, 0.76µm Gold (Au)  
Plating  
Status : Active

Series Number : 204843  
Product Category : Board-to-Board  
Connectors

Documents & Resources


Drawings  
Drawing 2048430001\_sd.pdf

3D Models and Design Files  
3D Model 2048430001\_stp.zip  
Electrical Model Document 2028281506EE-000.pdf  
S-Parameter Model 2028281506SP-000.zip

Specifications  
Application Specification 2028280001-AS-000.pdf  
Application Specification 2028289005PS-001.pdf  
Product Specification 2028280001-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements  
- Eu RoHS  
- REACH SVHC  
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

## EU RoHS Certificate of Compliance

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### Part Details

#### General

Status	Active
Category	Board-to-Board Connectors
Series	204843
Description	Mirror Mezz Hermaphroditic Connector, 2.50mm Connector Height, BGA-Attach Mounting, 7 Pair, 11 Row, 699 Circuits, 0.76µm Gold (Au) Plating
Application	Board-to-Board
Component Type	PCB Header
Product Family	Mirror Mezz Connectors
Product Name	Mirror Mezz
UPC	191128393027

#### Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	30V AC (RMS)/DC

#### Physical

Breakaway	No
Circuits (Loaded)	699
Circuits (maximum)	699
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	Yes
Keying to Mating Part	None

Lock to Mating Part	No
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	BGA Solder
Material - Resin	High Temperature Thermoplastic
Net Weight	5.257/g
Number of Rows	11
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	1.30mm
Plating min - Mating	0.762µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Yes
Stackable	Yes
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

## Solder Process Data

Max-Duration	20
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260

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## Mates With / Use With

### Mates with Part(s)

Description	Part Number
Mirror Mezz Hermaphroditic Connector, 5.50mm Connector Height, BGA-Attach Mounting, 7 Pair, 11 Row, 699 Circuits, 0.76µm Gold (Au) Plating	<u>2034560003</u>
Mirror Mezz Hermaphroditic Connectors	<u>204843</u>

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